

STU45N01-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)	
100	0.0185 at V _{GS} = 10 V	45	38 nC	

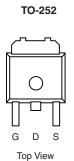
FEATURES

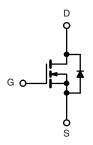
- Trench Power MOSFET
- 100 % $\rm R_{\rm g}$ and UIS Tested





- Primary Side Switch
- Isolated DC/DC Converter





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	S (T _A = 25 °C, unle	ess otherwise no	ited)		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage Gate-Source Voltage		V _{DS}	100	v	
		V _{GS}	± 20		
Continuous Drain Current (T _J = 150 °C) Pulsed Drain Current	T _C = 25 °C		45 ^a		
	T _C = 100 °C		30		
	T _A = 25 °C	I _D	9.2 ^b		
	T _A = 100 °C		6.8 ^b	A	
	<u>.</u>	I _{DM}	140		
Continuous Source-Drain Diode Current Single Pulse Avalanche Current	T _C = 25 °C	1	45 ^a		
	T _A = 25 °C	I _S	2 ^b		
	L = 0.1 mH	I _{AS}	35		
Avalanche Energy	L = 0.1 IIII1	E _{AS}	101	mJ	
levinour Peurs Dissipation	T _C = 25 °C		136.4		
	T _C = 100 °C	ь	68.2	w	
Maximum Power Dissipation	T _A = 25 °C	P _D —	3_p	VV	
	T _A = 100 °C		1.5 ^b		
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	40	50	°C/W
Maximum Junction-to-Case	Steady State	R _{thJC}	0.85	1.1	C/VV

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.



SPECIFICATIONS ($T_J = 25^{\circ}$	C, unless o	otherwise noted)				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L = 250 uA		110		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	l _D = 250 μA		- 12.5		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V			1	μА
Zero Gate Voltage Drain Current		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A		0.0185		Ω
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 15 A		33		S
Dynamic ^b						
Input Capacitance	C _{iss}			2400		
Output Capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		230		pF
Reverse Transfer Capacitance	C _{rss}			80		
Total Gate Charge	Q_g			38	70	nC
Gate-Source Charge	Q _{gs}	V _{DS} = 50 V, V _{GS} = 10 V, I _D = 50 A		14		
Gate-Drain Charge	e-Drain Charge Q _{gd}			12		
Gate Resistance	R_g	f = 1 MHz		1.6	2.5	Ω
Turn-On Delay Time	t _{d(on)}			12	20	
Rise Time	t _r	V_{DD} = 50 V, R_L = 1 Ω		10	20	- ns
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		18	35	
Fall Time	t _f			8	15	
Drain-Source Body Diode Characteris	stics					
Continuous Source-Drain Diode	I _S	T _C = 25 °C			35	^
Pulse Diode Forward Current ^a	I _{SM}				100	- A
Body Diode Voltage	V_{SD}	I _S = 15 A		0.85	1.5	V
Body Diode Reverse Recovery Time	t _{rr}			80	120	ns
Body Diode Reverse Recovery Charge	Q _{rr}	L = 50 A dl/dt = 100 A/uo T = 25 °C		160	240	nC
Reverse Recovery Fall Time	t _a	$I_F = 50 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °C$		57		ns
Reverse Recovery Rise Time	t _b			23		

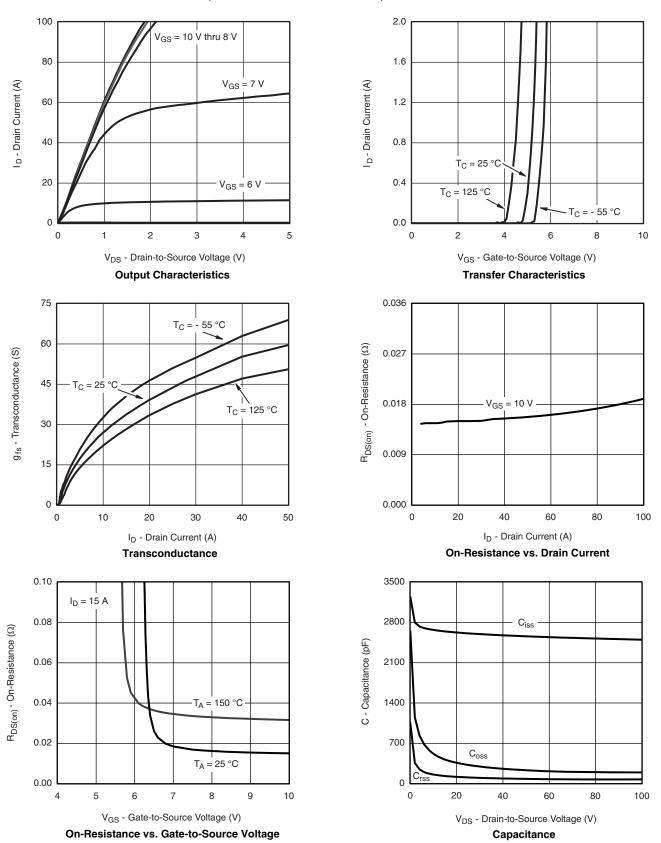
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise note)



服务热线:400-655-8788 3

0.001

0.01

0.1

Time (s)

Single Pulse Power, Junction-to-Ambient

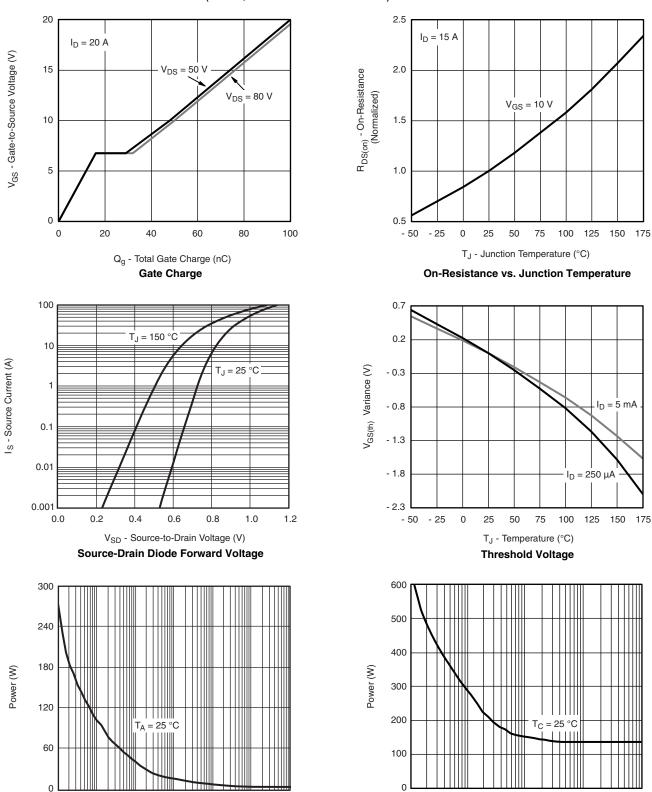
10

100

1000



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



4 服务热线:400-655-8788

0.001

0.01

0.1

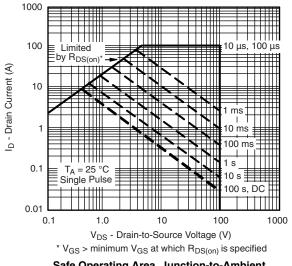
Time (s)

Single Pulse Power, Junction-to-Case

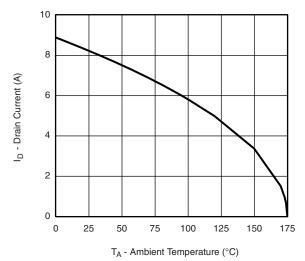
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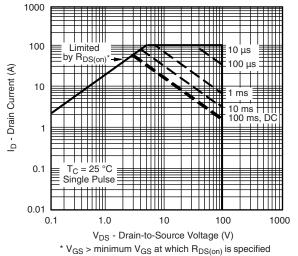
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



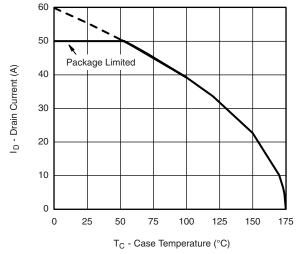




Current Derating**, Junction-to-Ambient



Safe Operating Area, Junction-to-Case

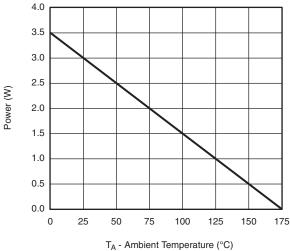


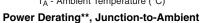
Current Derating**, Junction-to-Case

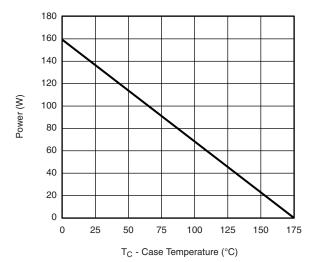
^{**} The power dissipation P_D is based on $T_{J(max.)}$ = 175 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





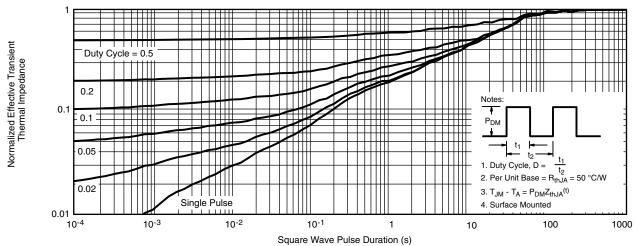


Power Derating**, Junction-to-Case

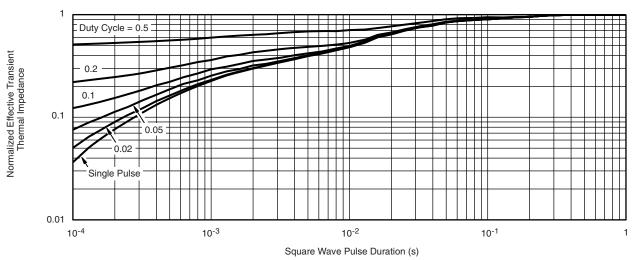
^{**} The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case



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